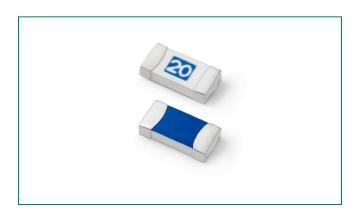
Surface Mount Fuses Ceramic Fuse > 501 Series

501 Series - High Current 1206 Fast-Acting Fuse





Agency Approvals

	AGENCY	AGENCY FILE NUMBER	AMPERE RANGE
	c% us E10480		10A - 20A
® ;		29862	10A - 20A

Electrical Characteristics for Series

% of Ampere Rating		
100%	10A – 20A	4 Hours, Minimum
350%	10A – 20A	5 Seconds, Maximum

Description

The 501 Series is a 100% Lead-free, RoHS compliant and Halogen-free fuse series designed specifically to provide over- current protection to circuits that operate under high working ambient temperature up to 150°C.

The general design ensures excellent temperature stability and performance reliability.

The high I²t values which is typical in the Littelfuse Ceramic Fuse family, ensure high inrush current withstand capability.

Features

- Operating Temperature from -55°C to +150°C
- Designed to provide over-current protection in high current voltage regulator module (VRM) applications
- 100% Lead-free, RoHS compliant and Halogenfree
- Suitable for both leaded and lead-free reflow / wave soldering

Applications

- Voltage Regulator Module (VRM) Equipment
- Notebook PC
- DC-DC Converter

Additional Information







Resources



Samples

Electrical Specifications by Item

Ampere	Ampere Rating (A) Amp Code	Max. Voltage		Nominal Nominal	Nominal Voltage	Nominal Power	Agency Approvals		
Rating		Rating (V)		Resistance (Ohms) ²	Melting I ² T (A ² Sec.) ³	Drop At Rated Current (V)4	Dissipation At	c M °us	(P)
10	010.	32		0.00362	10.385	0.04407	0.4407	х	Х
12	012.	32	150 A @ 32 VDC	0.00311	20.341	0.04927	0.5912	X	X
15	015.	32	150 A @ 32 VDC	0.00250	39.700	0.04843	0.7265	X	Х
20	020.	32		0.00194	86.360	0.05888	1.1776	х	Х

Notes

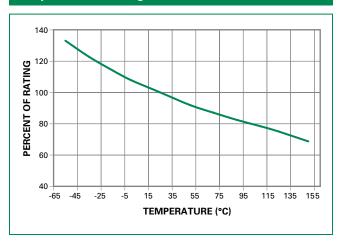
- 1. DC Interrupting Rating tested at rated voltage with time constant < 0.5 msec.
- 2. Nominal Resistance measured with < 10% rated current.
- 3. Nominal Melting I²t measured at 1 msec. opening time. For other I²t data refer to chart.
- Nominal Voltage Drop measured at rated current after temperature has stabilized and with fuse mounted on board with 3-oz Cu trace.

Devices designed to carry rated current for 4 hours minimum. It is recommended that devices be operated continuously at no more than 80% rated current. See "Temperature Re-rating Curve" for additional re-rating information.

Devices designed to be mounted with marking code facing up.



Temperature Re-rating Curve



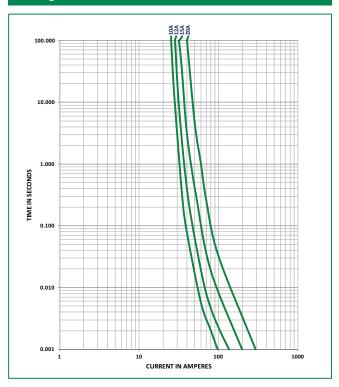
Note:

 Re-rating depicted in this curve is in addition to the standard re-rating of 20% for continuous operation.

Example:

For continuous operation at 75 degrees celsius, the fuse should be rerated as follows: $I=(0.80)(0.85)I_{RAT}=(0.68)I_{RAT}$

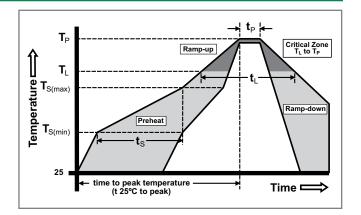
Average Time Current Curves



Soldering Parameters

Reflow Co	ndition	Pb – free assembly			
	-Temperature Min (T _{s(min)})	150°C			
Pre Heat	-Temperature Max (T _{s(max)})	200°C			
	-Time (Min to Max) (t _s)	60 – 180 seconds			
Average R (T _L) to pea	amp-up Rate (LiquidusTemp k)	3°C/second max.			
T _{S(max)} to T _I	- Ramp-up Rate	5°C/second max.			
Reflow	-Temperature (T _L) (Liquidus)	217°C			
nellow	-Temperature (t _L)	60 – 150 seconds			
PeakTemp	erature (T _P)	260+0/-5 °C			
Time with Temperatu	in 5°C of actual peak ure (t _p)	10 – 30 seconds			
Ramp-dov	vn Rate	6°C/second max.			
Time 25°C	to peakTemperature (T _P)	8 minutes max.			
Do not exc	ceed	260°C			

Wave Soldering	260°C, 10 seconds max.
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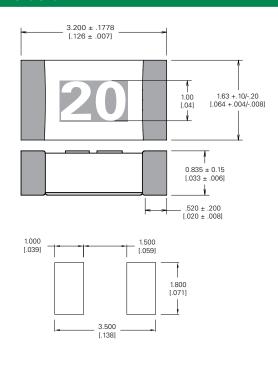
Surface Mount Fuses Ceramic Fuse > 501 Series

Product Characteristics

Materials	Body: Advanced Ceramic Terminations: Ag / Ni / Sn (100% Lead-free) Element Cover Coating: Lead-free Glass		
Moisture Sensitivity Level	IPC/JEDEC J-STD-020, Level 1		
Solderability	IPC/ECA/JEDEC J-STD-002, Condition B		
Humidity Test	MIL-STD-202, Method 103, Conditions D		
Resistance to Solvents	MIL-STD-202, Method 210, Condition B		

Moisture Resistance	MIL-STD-202, Method 106		
Thermal Shock	MIL-STD-202, Method 107, Condition B		
Mechanical Shock	MIL-STD-202, Method 213, Condition A		
Vibration	MIL-STD-202, Method 201		
Vibration, High Frequency	MIL-STD-202, Method 204, Condition D		
Dissolution of Metallization	IPC/ECA/JEDEC J-STD-002, Condition D		
Terminal Strength	IEC 60127-4		

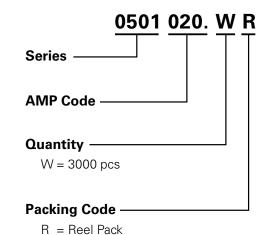
Dimensions



Part Marking System

Amp Code	Marking Code
010.	10
012.	12
015.	115
020.	20

Part Numbering System



Packaging

Packaging	Packaging	Quantity	Quantity &
Option	Specification		Packaging Code
8mm Tape and Reel	EIA-481, IEC 60286, Part 3	3000	WR

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